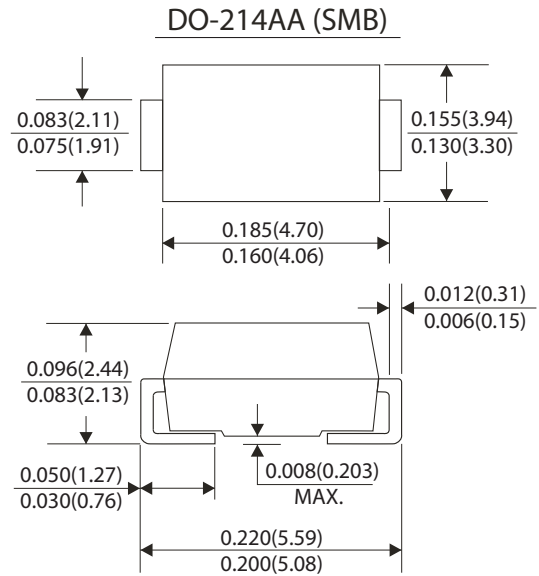


### Features

- Plastic Package has Underwriters Laboratory Flammability Classification 94V-0
- Metal silicon junction, majority carrier conduction
- For surface mount applications
- Guard ring for overvoltage protection
- Low power loss, high efficiency
- High current capability, Low forward voltage drop
- High surge capability
- For use in low voltage, high frequency inverters, free wheeling, and polarity protection applications
- High temperature soldering guaranteed : 250°C /10 seconds at terminals

### Mechanical Data

- Case : JEDEC SMB(DO-214AA) molded plastic body
- Terminals : Solder Plate, solderable per MIL-STD-750, Method 2026
- Polarity : Color band denotes cathode end
- Weight : 0.003 ounce, 0.093 gram



Dimensions in inches and (millimeters)

### Maximum Ratings and Electrical Characteristics

(Ratings at 25°C ambient temperature unless otherwise specified, single phase, half wave, resistive or inductive load. For capacitive load, derate by 20%)

	Symbols	SS32	SS33	SS34	SS35	SS36	SS38	SS39	SS310	Units
Maximum repetitive peak reverse voltage	V <sub>RRM</sub>	20	30	40	50	60	80	90	100	Volts
Maximum RMS voltage	V <sub>RMS</sub>	14	21	28	35	42	56	63	70	Volts
Maximum DC blocking voltage	V <sub>DC</sub>	20	30	40	50	60	80	90	100	Volts
Maximum average forward rectified current 0.375"(9.5mm) lead length(see Fig. 1)	I <sub>(AV)</sub>	3.0								Amps
Peak forward surge current 8.3ms single half sine-wave superimposed on rated load (JEDEC method)	I <sub>FSM</sub>	70.0								Amps
Maximum instantaneous forward voltage at 3.0A (Note 1)	V <sub>F</sub>	0.55			0.75		0.85			Volts
Maximum instantaneous reverse current at rated DC blocking voltage (Note1)	T <sub>A</sub> =25 °C	2.0								mA
	T <sub>A</sub> =100 °C	20								
Typical thermal resistance (Note 2)	R θ <sub>JA</sub>	17								°C/W
Operating junction temperature range	T <sub>J</sub>	-50 to +125								°C
Storage temperature range	T <sub>STG</sub>	-65 to +150								°C

#### Notes:

- (1) Pulse test: 300 μs pulse width, 1% duty cycle
- (2) Thermal resistance junction to ambient



# RATINGS AND CHARACTERISTIC CURVES SS32 THRU SS310

FIG.1-TYPICAL FORWARD CURRENT DERATING CURVE

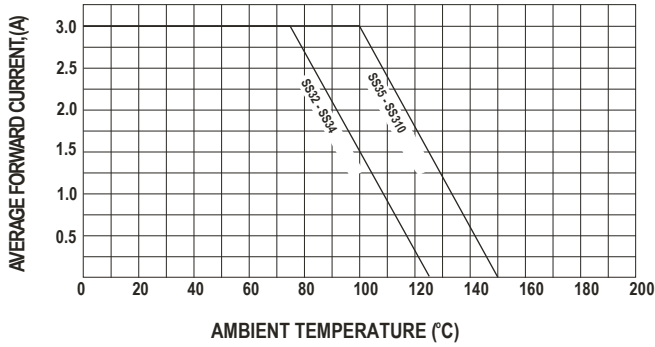


FIG.2-TYPICAL FORWARD CHARACTERISTICS

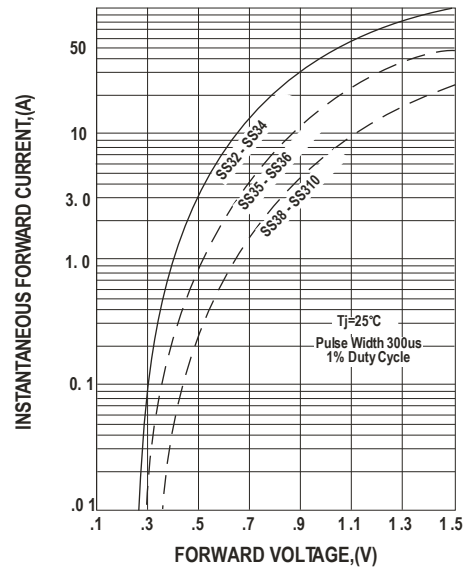


FIG.3-MAXIMUM NON-REPETITIVE FORWARD SURGE CURRENT

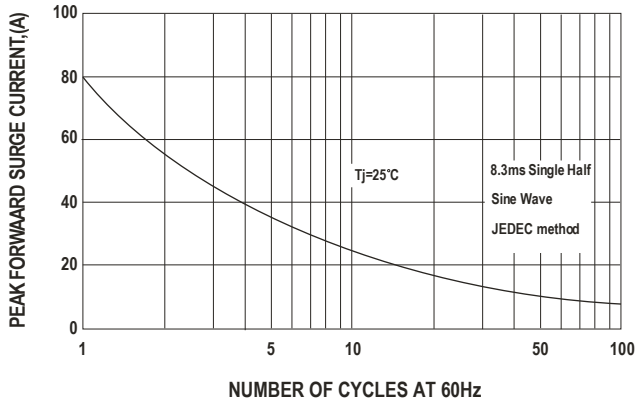


FIG.5 - TYPICAL REVERSE CHARACTERISTICS

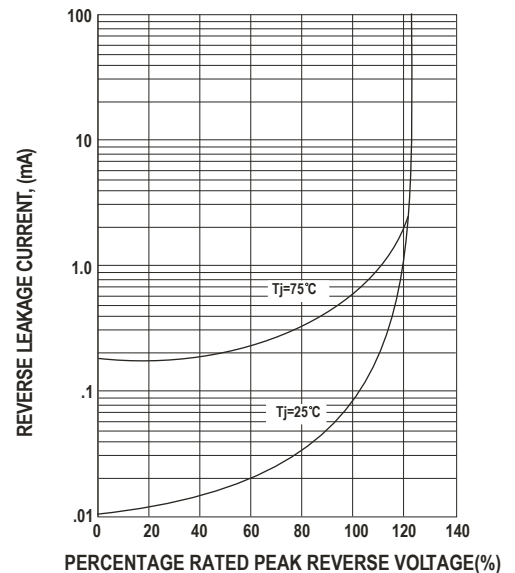


FIG.4-TYPICAL JUNCTION CAPACITANCE

